

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	4	wiring adj3 board and layer and first adj3 terminal and resist and metal and etching and hole and resin and solder and second adj3 electroplating	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/05/04 11:08
L2	4	wiring adj3 board and first adj3 terminal and metal and etching and hole and resin and solder and second adj3 electroplating	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/05/04 11:09
L3	4	wiring adj3 board and first adj3 terminal and hole and resin and solder and second adj3 electroplating	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/05/04 11:09
L4	4	wiring adj3 board and first adj3 terminal and resin and solder and second adj3 electroplating	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/05/04 11:10
L5	11	wiring adj3 board and first and terminal and resin and solder and second adj3 electroplating	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/05/04 11:10

775525 BOARD?
 73478 WIRING (3W) BOARD?
 4191387 FIRST
 962145 TERMINAL?
 9457 FIRST (3W) TERMINAL?
 407687 ETCH?
 1000271 HOLE?
 1898995 RESIN?
 200584 SOLDER?
 2112532 SECOND
 111860 ELECTROPLAT?
 62 SECOND (3W) ELECTROPLAT?
 S2 0 WIRING (3W) BOARD? AND FIRST (3W) TERMINAL? AND ETCH? AND
 HOLE? AND RESIN? AND SOLDER? AND SECOND (3W) ELECTROPLAT?
 ? s wiring(3w)board? and first(3w)terminal? and hole? and solder? and
 second(3w)electroplat?
 262865 WIRING
 775525 BOARD?
 73478 WIRING (3W) BOARD?
 4191387 FIRST
 962145 TERMINAL?
 9457 FIRST (3W) TERMINAL?
 1000271 HOLE?
 200584 SOLDER?
 2112532 SECOND
 111860 ELECTROPLAT?
 62 SECOND (3W) ELECTROPLAT?
 S3 0 WIRING (3W) BOARD? AND FIRST (3W) TERMINAL? AND HOLE? AND
 SOLDER? AND SECOND (3W) ELECTROPLAT?
 ? s wiring(3w)board? and first(3w)terminal? and solder? and second(3w)electroplat?
 262865 WIRING
 775525 BOARD?
 73478 WIRING (3W) BOARD?
 4191387 FIRST
 962145 TERMINAL?
 9457 FIRST (3W) TERMINAL?
 200584 SOLDER?
 2112532 SECOND
 111860 ELECTROPLAT?
 62 SECOND (3W) ELECTROPLAT?
 S4 0 WIRING (3W) BOARD? AND FIRST (3W) TERMINAL? AND SOLDER? AND
 SECOND (3W) ELECTROPLAT?
 ? s wiring(3w)board? and first(3w)terminal? and second(3w)electroplat?
 262865 WIRING
 775525 BOARD?
 73478 WIRING (3W) BOARD?
 4191387 FIRST
 962145 TERMINAL?
 9457 FIRST (3W) TERMINAL?
 2112532 SECOND
 111860 ELECTROPLAT?
 62 SECOND (3W) ELECTROPLAT?
 S5 0 WIRING (3W) BOARD? AND FIRST (3W) TERMINAL? AND
 SECOND (3W) ELECTROPLAT?
 ? s wiring(3w)board? and first and terminal? and second(3w)electroplat?
 262865 WIRING
 775525 BOARD?
 73478 WIRING (3W) BOARD?
 4191387 FIRST
 962145 TERMINAL?
 2112532 SECOND
 111860 ELECTROPLAT?
 62 SECOND (3W) ELECTROPLAT?

S6 0 WIRING (3W) BOARD? AND FIRST AND TERMINAL? AND
 SECOND (3W) ELECTROPLAT?
 ? s wiring(3w)board? and first and terminal? and electroplat? and solder
 262865 WIRING
 775525 BOARD?
 73478 WIRING (3W) BOARD?
 4191387 FIRST
 962145 TERMINAL?
 111860 ELECTROPLAT?
 118965 SOLDER
 S7 0 WIRING (3W) BOARD? AND FIRST AND TERMINAL? AND ELECTROPLAT?
 AND SOLDER
 ? s wiring(3w)board? and terminal? and electroplat? and solder and resin
 262865 WIRING
 775525 BOARD?
 73478 WIRING (3W) BOARD?
 962145 TERMINAL?
 111860 ELECTROPLAT?
 118965 SOLDER
 1416143 RESIN
 S8 3 WIRING (3W) BOARD? AND TERMINAL? AND ELECTROPLAT? AND
 SOLDER AND RESIN
 ? t s8/

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*File 345: Preview the enhanced INPADOC database in ONTAP File 253.
For more information, visit www.dialog.com/inpadoc.

Set Items Description

? s wiring(3w)board? and layer and first(3w)terminal? and resist? and metal and
etch? and hole? and resin? and solder? and second(3w)electroplat?

Processing

Processed 10 of 12 files ...

Completed processing all files

262865 WIRING
775525 BOARD?
73478 WIRING(3W)BOARD?
2129276 LAYER
4191387 FIRST
962145 TERMINAL?
9457 FIRST(3W)TERMINAL?
2723017 RESIST?
2887933 METAL
407687 ETCH?
1000271 HOLE?
1898995 RESIN?
200584 SOLDER?
2112532 SECOND
111860 ELECTROPLAT?
62 SECOND(3W)ELECTROPLAT?

S1 0 WIRING(3W)BOARD? AND LAYER AND FIRST(3W)TERMINAL? AND
RESIST? AND METAL AND ETCH? AND HOLE? AND RESIN? AND
SOLDER? AND SECOND(3W)ELECTROPLAT?

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solder? and second(3w)electroplat?

Processing

Processed 10 of 12 files ...

Completed processing all files

262865 WIRING